

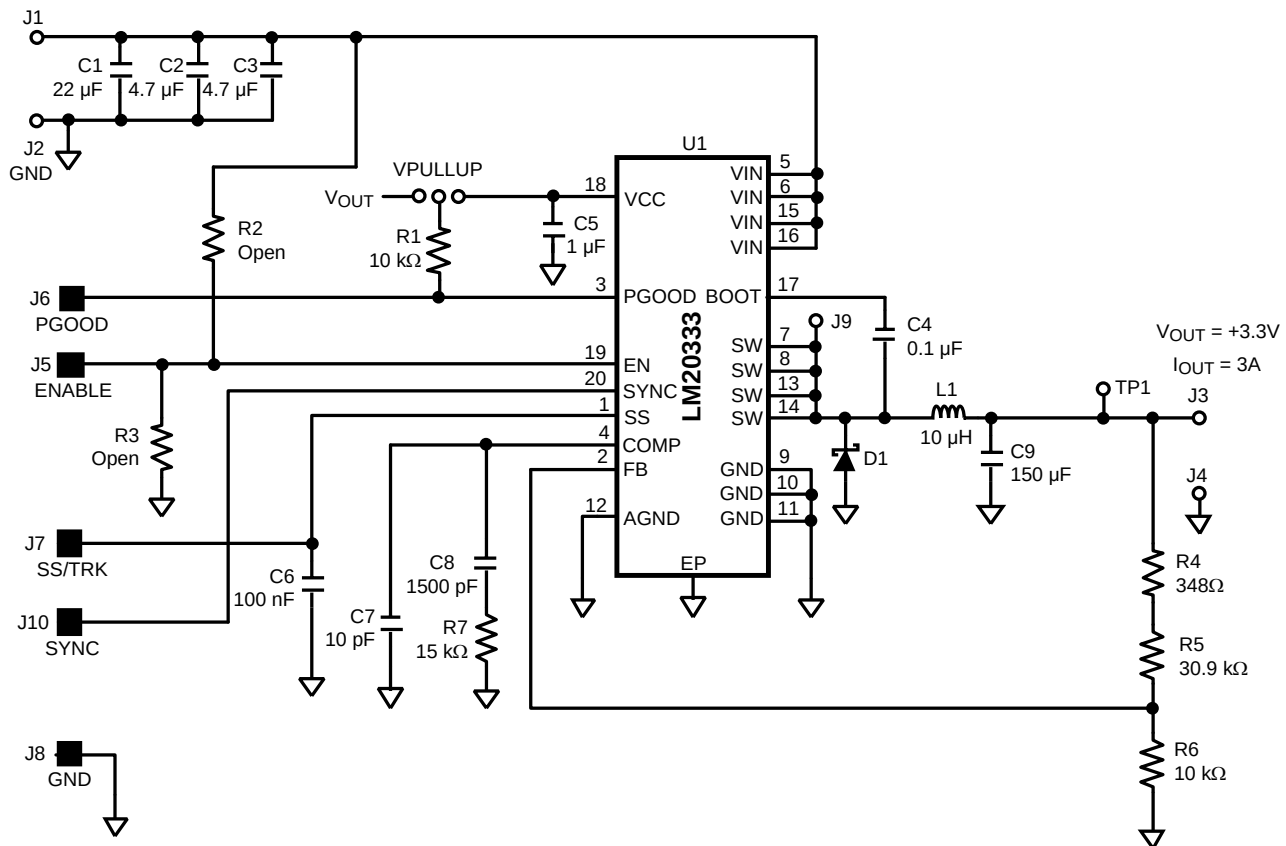
AN-1791 LM20333 Evaluation Board

1 Introduction

This evaluation board provides a solution to examine the full featured LM20333 buck switching regulator that is capable of driving up to 3A of load current. This device features a clock synchronization input that allows the switching frequency to be synchronized to an external clock source. The flexibility to synchronize the switching frequency from 250 kHz to 1.5 MHz allows the size of the power stage components to be reduced while still allowing for high efficiency. The LM20333 is capable of down converting from an input voltage between 4.5V and 36V. Fault protection features include cycle-by-cycle current limit, output power good, and output over-voltage protection. The dual function soft-start/tracking pin can be used to control the startup response of the LM20333, and the precision enable pin can be used to easily sequence the LM20333 in applications with sequencing requirements.

The LM20333 evaluation board has been optimized to work from 4.5V to 25V achieving a balance between overall solution size with the efficiency of the regulator. The evaluation board measures just under 2" x 2" on a four layer PCB, and exhibits a thermal characteristic of 27 °C/W with no air flow. The power stage and compensation components of the LM20333 evaluation board have been optimized for an input voltage of 12V, but for testing purposes, the input can be varied across the entire operating range. The output voltage of the evaluation board is nominally 3.3V, but this voltage can be easily changed by replacing one of the feedback resistors (R5 or R6).

2 Evaluation Board Schematic

 $V_{IN} = 4.5V - 25V$


3 Powering and Loading Considerations

Read this entire page prior to attempting to power the evaluation board.

3.1 Quick Setup Procedure

1. Set the input source current limit to 3A. Turn off the input source. Connect the positive output of the input source to J1 and the negative output to J2.
2. Connect the load, with 3A capability, to J3 for the positive connection and J4 for the negative connection.
3. Leave the ENABLE pin, J5, open for normal operation.
4. Set the input source voltage to 12V and the load to 0.1A. The load voltage should be in regulation with a nominal 3.3V output.
5. Slowly increase the load while monitoring the load voltage at J3 and J4. It should remain in regulation with a nominal 3.3V output as the load is increased up to 3 Amp.
6. Slowly sweep the input source voltage from 4.5V to 25V. The load voltage should remain in regulation with a nominal 3.3V output. If desired the output of the device can be disabled by connecting the ENABLE pin (J5) to GND (J8).
7. Select the pull-up voltage for PGOOD by using the JP1 shunt to connect VPULLUP to VOUT or VCC.
8. The frequency of operation can be varied as desired by connecting a signal.

3.2 Powering Up

It is suggested that the load power be kept low during the first power up. Set the current limit of the input source to provide about 1.5 times the anticipated wattage of the load. Once the device is powered up, immediately check for 3.3 volts at the output.

A quick efficiency check is the best way to confirm that everything is operating properly. If something is amiss you can be reasonably sure that it will affect the efficiency adversely. Few parameters can be incorrect in a switching power supply without creating losses and potentially damaging heat.

3.3 Over Current Protection

The evaluation board is configured with cycle-by-cycle over-current protection. This function is completely contained in the LM20333. The peak current is limited to approximately 5.2A.

Table 1. Connection Descriptions

Terminal Silkscreen	Description
VIN	This terminal is the input voltage to the device. The evaluation board will operation over the input voltage range of 4.5V to 25V. This voltage is limited due to the voltage rating of the input capacitors.
GND	These terminals are the ground connections to the device. There are three different GND connections on the PCB. J2 should be used for the input supply, J4 should be used for the load, and J8 should be used for low power signal connections such as ENABLE.
VOUT	This terminal connects to the output voltage of the power supply and should be connected to the load.
ENABLE	This terminal connects to the enable pin of the device. This terminal can be left floating or driven externally. If driven externally, a voltage typically less than 1.2V will disable the device. The operating voltage for this pin should not exceed 5.5V. The absolute maximum voltage rating on this pin is 6V.
SS/TRK	This terminal provides access to the SS/TRK pin of the device. Connections to this terminal are not needed for most applications. The feedback pin of the device will track the voltage on the SS/TRK pin if it is driven with an external voltage source that is below the 0.8V reference. The voltage on this pin should not exceed 5.5V during normal operation. The absolute maximum voltage rating on this pin is 6V.
PGOOD	This terminal connects to the power good output of the device. There is an option to connect this pin to VOUT or VCC through a 10 kΩ pull-up resistor. The voltage on this pin should not exceed 5.5V during normal operation and has an absolute maximum voltage rating of 6V.
JP1	This terminal block selects the pull-up voltage for the PGOOD pin to be either VCC or VOUT. An external voltage source for PGOOD may be supplied by connecting to the center terminal. The voltage applied to PGOOD should not exceed 5.5V during normal operation and has an absolute maximum voltage rating of 6V.
SW	This terminal allows easy probing of the switch node. Do not apply any external voltage source to this pin.
TP1 (VOUT)	This is a oscilloscope probe connector point used to measure the output ripple and transient response. It is design to work with most Tektronix oscilloscope probes and is the recommended measurement point for evaluating AC performance.
SYNC	This terminal connects to the SYNC pin of the device. If this pin is left open the switching frequency will default to approximately 200kHz. The voltage on this pin should not exceed 5.5V during normal operation and has an absolute maximum voltage rating of 6V.

4 Performance Characteristics

4.1 Efficiency Plots

Figure 1 shows the conversion efficiency versus output current for a 5V and 12V input voltage.

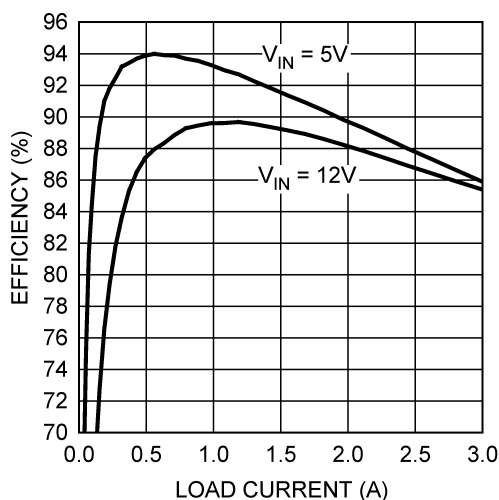


Figure 1. Conversion Efficiency Versus Output Current

4.2 Turn-On Waveform

When applying power to the LM20333 evaluation board, a soft-start sequence occurs. Figure 2 shows the output voltage during a typical start-up sequence.

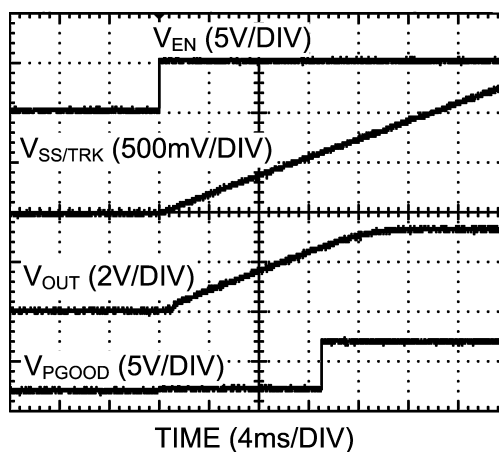
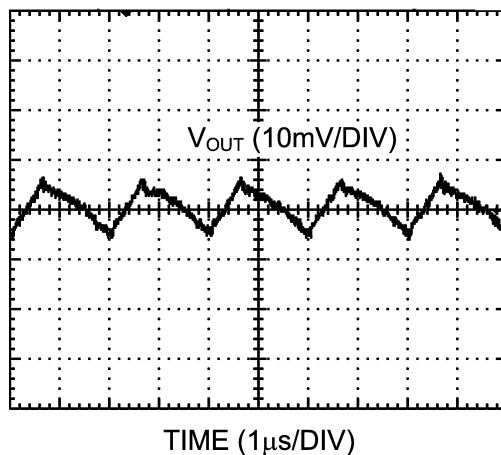


Figure 2. Output Voltage During a Typical Start-Up Sequence

4.3 Output Ripple Waveform

Figure 3 shows the output voltage ripple. This measurement was taken with the scope probe tip placed on the J3 load terminal and the scope probe ground "barrel" pushed against the J4 load terminal. The scope bandwidth is set to 20 MHz.



Bandwidth Limit = 20 MHz

Figure 3. Output Voltage Ripple

4.4 Primary Switchnode Voltage

Figure 4 shows the typical SW pin voltage while synchronizing to an external source.

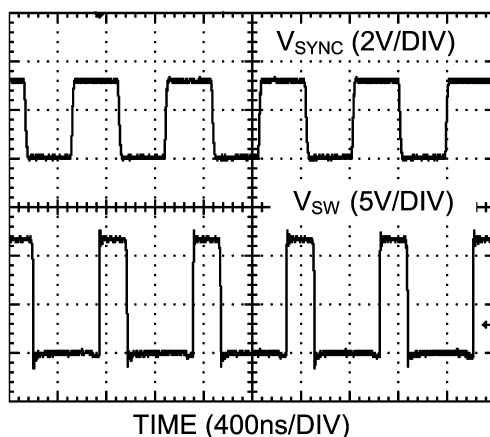


Figure 4. Typical SW Pin Voltage

4.5 Output Transient Response

Figure 5 shows the output transient response during a 300mA to 3A transient.

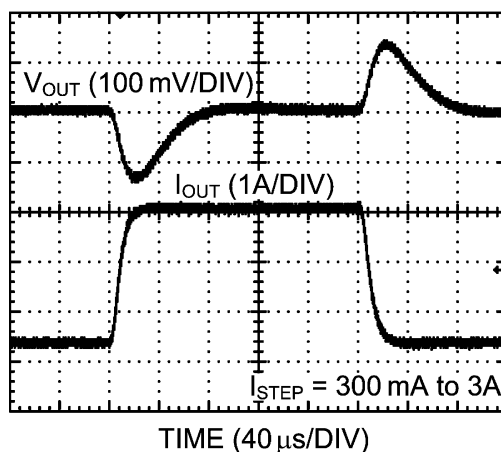


Figure 5. Output Transient Response

5 Bill of Materials (BOM)

The Bill of Materials is shown Table 2, including the manufacturer and part number.

Table 2. Bill of Materials (BOM)

DESIGNATOR	QTY	PART NUMBER	DESCRIPTION	VALUE
C1	1	GRM32ER61E226KE15	CAPACITOR, 1210 X5R CER, MURATA	22 μ F, 25V
C2, C3	2	GRM21BR61E475KA12L	CAPACITOR, 0805 X5R CER, MURATA	4.7 μ F, 25V
C5	1	GRM188R71A105KA61D	CAPACITOR, 0603 X7R CER, MURATA	1 μ F, 10V
C4, C6	2	C1608X7R1H104K	CAPACITOR, 0603 X7R CER, TDK	0.1 μ F, 50V
C7	1	C1608C0G1H100J	CAPACITOR, 0603 COG CER, TDK	10 pF, 50V
C8	1	C1608C0G1H152J	CAPACITOR, 0603 COG CER, TDK	1500 pF, 50V
C9	1	6TPB150MAZB	CAPACITOR, POSCAP B, SANYO	150 μ F, 6.3V
D1	1	CMMSH1-40-NST	DIODE, SCHOTTKY, CENTRAL SEMI	1A, 40V
L1	1	IHLP4040DZER10R0M11	INDUCTOR, VISHAY	10 μ H, 7.1A
R1, R6	2	CRCW06031002F	RESISTOR, 0603, VISHAY	10 k Ω
R7	1	CRCW06031502F	RESISTOR, 0603, VISHAY	15 k Ω
R2, R3	0	OPEN	-	-
R4	1	CRCW0603348RF	RESISTOR, 0603, VISHAY	348 Ω
R5	1	CRCW06033092F	RESISTOR, 0603, VISHAY	30.9 k Ω
U1	1	LM20333	SWITCHING REGULATOR, Texas Instruments	
J1 - J4	4	160-1026-02-01-00	TURRET TERMINAL, CAMBION	TERMINAL, TURRET
J6, J7, J9, J10	4	5002	TERMINAL, SINGLE PIN, KEYSTONE	TESTPOINT, LOOP
J5	1	5000	TERMINAL, SINGLE PIN, KEYSTONE	TESTPOINT, LOOP
J8	1	5001	TERMINAL, SINGLE PIN, KEYSTONE	TESTPOINT, LOOP
TP1	1	131503100	TEKTRONIX SCOPE PROBE TESTPOINT	PROBE TESTPOINT

6 Component Selection

This section provides a walk-through of the design process of the LM20333 evaluation board. Unless otherwise indicated all equations assume units of amps (A) for current, farads (F) for capacitance, henries (H) for inductance, and volts (V) for voltages.

6.1 Input Capacitors: C1, C2, C3

The required RMS current rating of the input capacitor for a buck regulator can be estimated by the following equation:

$$I_{CIN(RMS)} = I_{OUT} \sqrt{D(1-D)} \quad (1)$$

The variable D refers to the duty cycle, and can be approximated by:

$$D = \frac{V_{OUT}}{V_{IN}} \quad (2)$$

From this equation, it follows that the maximum $I_{CIN(RMS)}$ requirement will occur at a full 3A load current with the system operating at 50% duty cycle. Under this condition, the maximum $I_{CIN(RMS)}$ is given by:

$$I_{CIN(RMS)} = 3A \sqrt{0.5 \times 0.5} = 1.5A \quad (3)$$

Ceramic capacitors feature a very large I_{RMS} rating in a small footprint, making a ceramic capacitor ideal for this application. A two 4.7 μ F, X5R, 25V ceramic capacitor(C2, C3) from Murata are used to provide the necessary input capacitance for the evaluation board. An additional 22 μ F, X5R, 25V capacitor is used to provide additional input capacitance to counter cabling inductance to the input.

6.2 Inductor: L1

The value of the inductor was selected to allow the device to achieve a 12V to 3.3V conversion at 250kHz to provide a peak to peak ripple current 957mA, which is about 32% of the maximum output current. To have an optimized design, generally the peak to peak inductor ripple current should be kept to within 20% to 40% of the rated output current for a given input voltage, output voltage and operating frequency. The peak to peak inductor ripple current can be calculated by the equation:

$$\Delta I_{P-P} = \frac{(V_{IN} - V_{OUT}) \times D}{L \times f_{SW}} \quad (4)$$

Once an inductance value is calculated, an actual inductor needs to be selected based on a trade-off between physical size, efficiency, and current carrying capability. For the LM20333 evaluation board, a Vishay IHLP4040DZER10R0M11 inductor offers a good balance between efficiency (28 m Ω DCR), size, and saturation current rating (7.1A I_{SAT} rating).

6.3 Output Capacitor: C9

The value of the output capacitor in a buck regulator influences the voltage ripple that will be present on the output voltage, as well as the large signal output voltage response to a load transient. Given the peak-to-peak inductor current ripple (ΔI_{P-P}) the output voltage ripple can be approximated by the equation:

$$\Delta V_{OUT} = \Delta I_{P-P} \times \left[R_{ESR} + \frac{1}{8 \times f_{SW} \times C_{OUT}} \right] \quad (5)$$

The variable R_{ESR} above refers to the ESR of the output capacitor. As can be seen in the above equation, the ripple voltage on the output can be divided into two parts, one of which is attributed to the AC ripple current flowing through the ESR of the output capacitor and another due to the AC ripple current actually charging and discharging the output capacitor. The output capacitor also has an effect on the amount of droop that is seen on the output voltage in response to a load transient event.

For the evaluation board, a Sanyo 150 μ F POSCAP output capacitor was selected to provide good transient and DC performance in a relatively small package. From the technical specifications of this capacitor, the ESR is roughly 35 m Ω , and RMS ripple current rating is 1.4A. With these values, the worst case peak to peak voltage ripple on the output when operating from a 12V input can be calculated to be 37 mV.

6.4 Soft-Start Capacitor: C6

A soft-start capacitor can be used to control the startup time of the LM20333 voltage regulator. The startup time of the regulator when using a soft-start capacitor can be estimated by the following equation:

$$t_{SS} = \frac{0.8V \times C6}{I_{SS}} \quad (6)$$

For the LM20333, I_{SS} is nominally 5 μ A. For the evaluation board, the soft-start time has been designed to be roughly 15 ms, resulting in a C_{SS} capacitor value of 100 nF.

6.5 VCC Bypass: C5

The capacitor C5 is used to bypass the internal 4.5V sub-regulator. A value of 1 μ F is sufficient for most applications.

6.6 Boot Capacitor: C4

C4 is the boot capacitor which is used to provide the charge needed to drive the high-side FET. An optimal value for this capacitor is 0.1 μ F.

6.7 Compensation Capacitor: C8

The capacitor C8 is used to set the crossover frequency of the LM20333 control loop. Since this board was optimized to be stable over the full input and output voltage range, the value of C8 was selected to be 1.5 nF. Once the operating conditions for the device are known, the transient response can be optimized by reducing the value of C8 and calculating the value for R7 as outlined in the next section.

6.8 Compensation Resistor: R7

Once the value of C8 is known, resistor R7 is used to place a zero in the control loop to cancel the output filter pole. This resistor can be sized according to the equation:

$$R7 = \left[\frac{C8}{C9} \times \left[\frac{I_{OUT}}{V_{OUT}} + \frac{2 \times D}{f_{SW} \times L1} \right] \right]^{-1} \quad (7)$$

For stability purposes the device should be compensated for the maximum output current expected in the application.

6.9 Optional Compensation Capacitor: C7

A second compensation capacitor C7 can be used in some designs to improve noise immunity for low duty cycle conversions, as well as, provide a high frequency pole, useful for cancelling a possible zero introduced by the ESR of the output capacitor. For the LM20333 evaluation board, a 10pF capacitor is populated for C7. Higher value capacitors can be used to improve low duty cycle performance at the expense of phase margin.

6.10 Feedback resistors: R4, R5, and R6

The resistors labeled R5 and R6 create a voltage divider from V_{OUT} to the feedback pin that is used to set the output of the voltage regulator. Nominally, the output of the LM20333 evaluation board is set to 3.3V, giving resistor values of R5 = 30.9 k Ω and R6 = 10 k Ω . If a different output voltage is required, the value of R5 can be adjusted according to the equation:

$$R5 = \left(\frac{V_{OUT}}{0.8} - 1 \right) \times R6 \quad (8)$$

R6 does not need to be changed from its value of 10 k Ω . Resistor R4 has a value of 348 Ω and is provided as an injection point for loop stability measurements, as well as, a way to further tweak the output voltage accuracy to account for resistor tolerance values differing from ideal calculated values.

6.11 Programmable UVLO: R2 and R3

The resistors labeled R2 and R3 create a voltage divider from V_{IN} to the enable pin that can be used to set the turn-on threshold or UVLO of the voltage regulator. To allow evaluation of the device down to 4.5V these components are not installed. To change the turn-on threshold of the device a 10 k Ω resistor is recommended for R3 and the value of R2 can be calculated using the equation:

$$R2 = \left(\frac{V_{TO}}{1.25} - 1 \right) \times R3 \quad (9)$$

7 PCB Layout

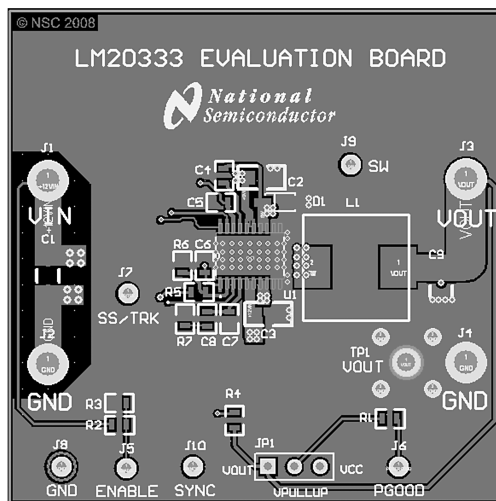


Figure 6. Top Layer

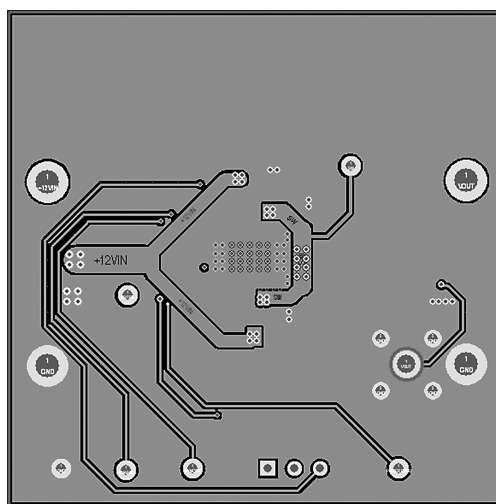


Figure 7. Mid Layer1

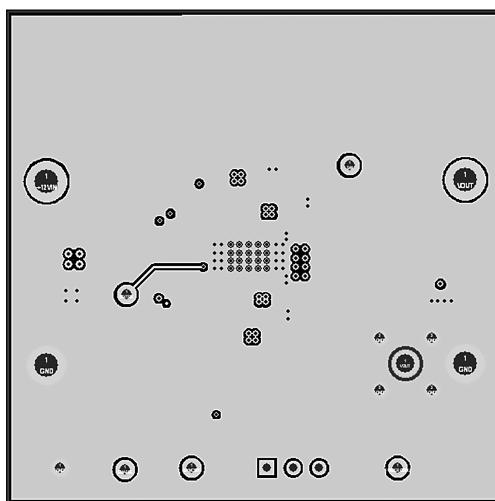


Figure 8. Mid Layer2

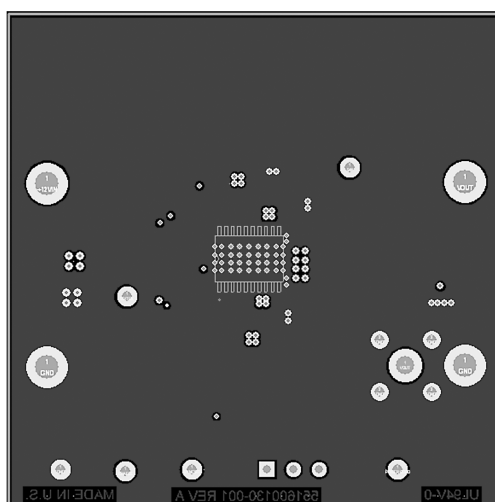


Figure 9. Bottom Layer

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